

JPW



S&H Form: (2/01)
DOCKET NO. 1793.1266

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Joo-ho KIM, et al.

Serial No: 10/849,522

Group Art Unit: 1752

Confirmation No. 5579

Filed: May 20, 2004

Examiner: Unassigned

For: MULTI-LAYER STRUCTURE AND METHOD OF DRAWING MICROSCOPIC
STRUCTURE THEREIN, OPTICAL DISC MASTER AND METHOD OF FABRICATING
THE SAME USING THE MULTI-LAYER STRUCTURE, AND OPTICAL DISC
MANUFACTURED USING THE OPTICAL DISC MASTER

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

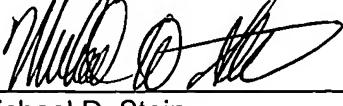
Sir:

It is requested that the spelling of the fourth Applicant's address on the Official Filing Receipt be corrected. The correct spelling of the fourth Applicant's address is "Tsukubasi, Japan", as is evidenced by the executed Declaration, attached to the application as filed. For the convenience of the Patent and Trademark Office, attached is a photocopy of the original receipt on which the errors have been noted in red.

It is requested that a corrected Official Filing Receipt be issued in this application.

Respectfully submitted,

STAAS & HALSEY LLP

Date: 9/21/04
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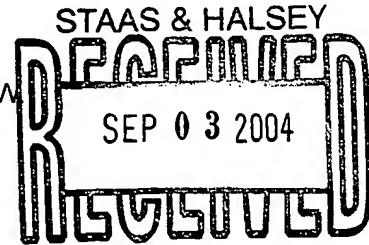


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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/849,522	05/20/2004	1752	2402	1793.1266	15	70	10

21171
STAAS & HALSEY LLP
SUITE 700
1201 NEW YORK AVENUE, N.W.
WASHINGTON, DC 20005



CONFIRMATION NO. 5579

UPDATED FILING RECEIPT



OC000000013690738

Date Mailed: 09/01/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Joo-ho Kim, Yongin-si, KOREA, REPUBLIC OF;
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Assignment For Published Patent Application

Samsung Electronics Co., Ltd., Suwon-si, KOREA, REPUBLIC OF

Power of Attorney: The patent practitioners associated with Customer Number 27171.**Domestic Priority data as claimed by applicant****Foreign Applications**

JAPAN 2003-143624 05/21/2003.

If Required, Foreign Filing License Granted: 07/16/2004**The number of your priority application, to be used for filing abroad under the Paris Convention is,
US10/849,522****Projected Publication Date:** 12/09/2004

Non-Publication Request: No



Early Publication Request: No

Title

Multi-layer structure and method of drawing microscopic structure therein, optical disc master and method of fabricating the same using the multi-layer structure, and optical disc manufactured using the optical disc master

Preliminary Class

430

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Schedule

June 2004	TCs 1600, 1700, 2800 and 2900
July 2004	TCs 3600 and 3700
August 2004	TCs 2100 and 2600

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Form (Rev. 2/01)

UNITED STATES

Docket No.: 1793.1266

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

As a below named inventor, I hereby declare that

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **MULTI-LAYER STRUCTURE AND METHOD OF DRAWING MICROSCOPIC STRUCTURE THEREIN, OPTICAL DISC MASTER AND METHOD OF FABRICATING THE SAME USING THE MULTI-LAYER STRUCTURE, AND OPTICAL DISC MANUFACTURED USING THE OPTICAL DISC MASTER**

the specification of which is attached hereto, unless the following box is checked:

was filed on 20 May 2004 as United States Application Number or PCT International Application Number 10/849,522 and was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(s) under 35 U.S.C. § 119(a)-(d) or § 365(a)-(c) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)Priority NOT
Claimed

<u>2003-143624</u> (Number)	<u>Japan</u> (Country)	<u>21/May/2003</u> Day/Month/Year Filed	<input type="checkbox"/>
<u> </u> (Number)	<u> </u> (Country)	<u> </u> Day/Month/Year Filed	<input type="checkbox"/>

I hereby claim the benefit under 35 U.S.C. § 120 or § 119(e) of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

<u>(Application Serial No.)</u>	<u>(Filing Date)</u>	<u>(Status – patented, pending, abandoned)</u>
<u>(Application Serial No.)</u>	<u>(Filing Date)</u>	<u>(Status – patented, pending, abandoned)</u>

I hereby appoint the attorneys and agents of Staas & Halsey LLP under USPTO Customer No. 21,171 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

21171
PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Joo-ho KIM

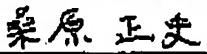
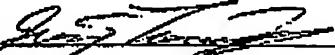
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Additional inventors are being named on separately numbered sheets attached hereto.

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

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Full name of sixth Inventor _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Mailing Address _____

Full name of seventh inventor _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Mailing Address _____

Full name of eighth Inventor _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Mailing Address _____

Full name of ninth Inventor _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Mailing Address _____